

# 1 $\Omega$ Typical On Resistance, ±5 V, +12 V, +5 V, and +3.3 V, 4:1 Multiplexer

# ADG1604

#### **FEATURES**

1 Ω typical on resistance
0.2 Ω on resistance flatness
±3.3 V to ±8 V dual supply operation
3.3 V to 16 V single supply operation
No V<sub>L</sub> supply required
3 V logic-compatible inputs
Rail-to-rail operation
Continuous current per channel
LFCSP package: 504 mA
TSSOP package: 315 mA
14-lead TSSOP and 16-lead, 4 mm × 4 mm LFCSP

#### **APPLICATIONS**

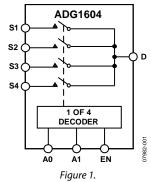
Communication systems Medical systems Audio signal routing Video signal routing Automatic test equipment Data acquisition systems Battery-powered systems Sample-and-hold systems Relay replacements

#### **GENERAL DESCRIPTION**

The ADG1604 is a complementary metal-oxide semiconductor (CMOS) analog multiplexer and switches one of four inputs to a common output, D, as determined by the 3-bit binary address lines, A0, A1, and EN. Logic 0 on the EN pin disables the device. Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked. All switches exhibit break-before-make switching action. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

The ultralow on resistance of these switches make them ideal solutions for data acquisition and gain switching applications where low on resistance and distortion is critical. The on resistance profile is very flat over the full analog input range, ensuring excellent linearity and low distortion when switching audio signals.

### FUNCTIONAL BLOCK DIAGRAM



The CMOS construction ensures ultralow power dissipation, making the parts ideally suited for portable and batterypowered instruments.

#### **PRODUCT HIGHLIGHTS**

- 1. 1.6  $\Omega$  maximum on resistance over temperature.
- 2. Minimum distortion: THD + N = 0.007%.
- 3. 3 V logic-compatible digital inputs:  $V_{INH} = 2.0$  V,  $V_{INL} = 0.8$  V.
- 4. No  $V_L$  logic power supply required.
- 5. Ultralow power dissipation: <16 nW.
- 6. 14-lead TSSOP and 16-lead,  $4 \text{ mm} \times 4 \text{ mm}$  LFCSP.

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### **REVISION HISTORY**

1/09—Revision 0: Initial Version

### **SPECIFICATIONS**

### ±5 V DUAL SUPPLY

 $V_{\text{DD}}$  = +5 V  $\pm$  10%,  $V_{\text{SS}}$  = -5 V  $\pm$  10%, GND = 0 V, unless otherwise noted.

#### Table 1.

Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V <sub>DD</sub> to V <sub>SS</sub>	V	
On Resistance (R <sub>ON</sub> )	1			Ωtyp	$V_s = \pm 4.5 V$ , $I_s = -10 mA$ ; see Figure 22
	1.2	1.4	1.6	Ωmax	$V_{DD} = \pm 4.5 V, V_{SS} = \pm 4.5 V$
On Resistance Match Between Channels ( $\Delta R_{ON}$ )	0.04			Ωtyp	$V_{s} = \pm 4.5 V$ , $I_{s} = -10 mA$
	0.08	0.09	0.1	Ωmax	
On Resistance Flatness (R <sub>FLAT(ON)</sub> )	0.2			Ωtyp	$V_s = \pm 4.5 V$ , $I_s = -10 mA$
	0.25	0.29	0.34	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +5.5 V, V_{SS} = -5.5 V$
Source Off Leakage, Is (Off)	±0.1			nA typ	$V_s = \pm 4.5 V$ , $V_D = \mp 4.5 V$ ; see Figure 23
	±0.2	±1	±8	nA max	······································
Drain Off Leakage, I <sub>D</sub> (Off)	±0.2	÷'	±0	nA typ	$V_{s} = \pm 4.5 V$ , $V_{D} = \mp 4.5 V$ ; see Figure 23
bruin on Leakage, in (on)	±0.2	±2	±16	nA max	$v_5 = \pm 4.5v, v_0 = \pm 4.5v, see Figure 25$
Channel On Leakage L. L. (On)	±0.2 ±0.2	ΞZ	±10		$\lambda = \lambda = \pm 4 E \lambda \cos 24$
Channel On Leakage, I <sub>D</sub> , I <sub>s</sub> (On)		. 2	110	nA typ	$V_s = V_D = \pm 4.5 V$ ; see Figure 24
DIGITAL INPUTS	±0.4	±2	±16	nA max	
			2.0	Mara in	
Input High Voltage, V <sub>INH</sub>			2.0	V min	
Input Low Voltage, V <sub>INL</sub>	0.005		0.8	V max	
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.005			µA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	µA max	
Digital Input Capacitance, C <sub>IN</sub>	8			pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>					
Transition Time, transition	150			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	278	336	376	ns max	V <sub>s</sub> = 2.5 V; see Figure 29
t <sub>on</sub> (EN)	116			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	146	166	177	ns max	$V_s = 2.5 V$ ; see Figure 31
t <sub>off</sub> (EN)	186			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	234	277	310	ns max	$V_s = 2.5 V$ ; see Figure 31
Break-Before-Make Time Delay, t <sub>D</sub>	50			ns typ	$R_L = 300 \ \Omega, C_L = 35 \ pF$
			28.5	ns min	$V_{s1} = V_{s2} = 2.5 V$ ; see Figure 30
Charge Injection	140			pC typ	$V_s = 0 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 32
Off Isolation	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 25
Channel-to-Channel Crosstalk	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 27
Total Harmonic Distortion + Noise (THD + N)	0.007			% typ	$R_L = 110 \Omega$ , 5 V p-p, f = 20 Hz to 20 kHz; see Figure 28
–3 dB Bandwidth	15			MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 26
C <sub>s</sub> (Off)	63			pF typ	$V_{s} = 0 V, f = 1 MHz$
C <sub>D</sub> (Off)	270			pF typ	$V_{s} = 0 V, f = 1 MHz$
C <sub>D</sub> , C <sub>s</sub> (On)	360			pF typ	$V_{s} = 0 V, f = 1 MHz$
POWER REQUIREMENTS	1				$V_{DD} = +5.5 \text{ V}, \text{ V}_{SS} = -5.5 \text{ V}$
IDD	0.001		1.0	μA typ	Digital inputs = $0 \text{ V or } V_{DD}$
			1.0	µA max	
V <sub>DD</sub> /V <sub>SS</sub>			±3.3/±8	V min/max	

### **12 V SINGLE SUPPLY**

 $V_{\text{DD}}$  = 12 V  $\pm$  10%,  $V_{\text{SS}}$  = 0 V, GND = 0 V, unless otherwise noted.

### Table 2.

Parameter	25°C	–40°C to +85°C	–40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V <sub>DD</sub>	V	
On Resistance (R <sub>ON</sub> )	0.95			Ωtyp	$V_s = 0 V$ to 10 V, $I_s = -10 mA$ ; see Figure 22
	1.1	1.25	1.45	Ωmax	$V_{DD} = 10.8 V, V_{SS} = 0 V$
On Resistance Match Between Channels ( $\Delta R_{ON}$ )	0.03			Ωtyp	$V_s = 10 V$ , $I_s = -10 mA$
	0.06	0.07	0.08	Ωmax	
On Resistance Flatness (R <sub>FLAT(ON)</sub> )	0.2			Ωtyp	$V_{s} = 0 V$ to 10 V, $I_{s} = -10 \text{ mA}$
	0.23	0.27	0.32	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 13.2 V, V_{SS} = 0 V$
Source Off Leakage, Is (Off)	±0.1			nA typ	$V_{s} = 1 V/10 V$ , $V_{D} = 10 V/1 V$ ; see Figure 23
	±0.2	±1	±8	nA max	
Drain Off Leakage, I₂ (Off)	±0.1			nA typ	$V_{s} = 1 V/10 V$ , $V_{D} = 10 V/1 V$ ; see Figure 23
	±0.2	±2	±16	nA max	
Channel On Leakage, I <sub>D</sub> , I <sub>s</sub> (On)	±0.2			nA typ	$V_s = V_D = 1 V \text{ or } 10 V$ ; see Figure 24
	±0.4	±2	±16	nA max	
DIGITAL INPUTS					
Input High Voltage, V <sub>INH</sub>			2.0	V min	
Input Low Voltage, V <sub>INL</sub>			0.8	V max	
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.001			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	µA max	
Digital Input Capacitance, C <sub>IN</sub>	8			pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>					
Transition Time, transition	100			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	161	192	220	ns max	V <sub>s</sub> = 8 V; see Figure 29
ton (EN)	80			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	95	104	111	ns max	$V_s = 8 V$ ; see Figure 31
toff (EN)	144			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	173	205	234	ns max	$V_s = 8 V$ ; see Figure 31
Break-Before-Make Time Delay, t <sub>D</sub>	25			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
			18	ns min	$V_{s1} = V_{s2} = 8 V$ ; see Figure 30
Charge Injection	125			pC typ	$V_s = 6 V, R_s = 0 \Omega, C_L = 1 nF$ ; see Figure 32
Off Isolation	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 25
Channel-to-Channel Crosstalk	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 27
Total Harmonic Distortion + Noise	0.013			% typ	$R_L$ = 110 Ω, 5 Vp-p, f = 20 Hz to 20 kHz; see Figure 28
–3 dB Bandwidth	19			MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 26
Cs (Off)	60			pF typ	$V_s = 6 V, f = 1 MHz$
$C_{D}$ (Off)	270			pF typ	$V_{s} = 6 V, f = 1 MHz$
C <sub>D</sub> , C <sub>s</sub> (On)	350			pF typ	$V_{s} = 6 V, f = 1 MHz$
POWER REQUIREMENTS					$V_{DD} = 12 V$
l <sub>DD</sub>	0.001			μA typ	Digital inputs = $0 \text{ V}$ or $V_{DD}$
			1	µA max	
ldd	230			µA typ	Digital inputs = 5 V
			360	µA max	
V <sub>DD</sub>			3.3/16	V min/max	

### **5 V SINGLE SUPPLY**

 $V_{\text{DD}}$  = 5 V  $\pm$  10%,  $V_{\text{SS}}$  = 0 V, GND = 0 V, unless otherwise noted.

### Table 3.

Parameter	25°C	–40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V <sub>DD</sub>	v	
On Resistance (R <sub>ON</sub> )	1.7			Ωtyp	$V_{s} = 0 V$ to 4.5 V, $I_{s} = -10 mA$ ; see Figure 22
	2.15	2.4	2.7	Ωmax	$V_{DD} = 4.5 V, V_{SS} = 0 V$
On Resistance Match Between Channels ( $\Delta R_{ON}$ )	0.05			Ωtyp	$V_s = 0 V$ to 4.5 V, $I_s = -10 mA$
	0.09	0.12	0.15	Ωmax	
On Resistance Flatness (R <sub>FLAT(ON)</sub> )	0.4			Ωtyp	$V_s = 0 V$ to 4.5 V, $I_s = -10 mA$
	0.53	0.55	0.6	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 5.5 V, V_{SS} = 0 V$
Source Off Leakage, Is (Off)	±0.05			nA typ	$V_s = 1 V/4.5 V$ , $V_D = 4.5 V/1 V$ ; see Figure 23
	±0.2	±1	±8	nA max	
Drain Off Leakage, I <sub>D</sub> (Off)	±0.05			nA typ	$V_s = 1 V/4.5 V$ , $V_D = 4.5 V/1 V$ ; see Figure 23
	±0.2	±2	±16	nA max	
Channel On Leakage, ID, Is (On)	±0.1			nA typ	$V_s = V_D = 1 V \text{ or } 4.5 V$ ; see Figure 24
	±0.4	±2	±16	nA max	
DIGITAL INPUTS					
Input High Voltage, V <sub>INH</sub>			2.0	V min	
Input Low Voltage, V <sub>INL</sub>			0.8	V max	
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.001			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	μA max	
Digital Input Capacitance, C <sub>IN</sub>	8			pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>					
Transition Time, transition	175			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	283	337	380	ns max	V <sub>s</sub> = 2.5 V; see Figure 29
t <sub>on</sub> (EN)	135			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	174	194	212	ns max	$V_s = 2.5 V$ ; see Figure 31
t <sub>off</sub> (EN)	228			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	288	342	385	ns max	$V_s = 2.5 V$ ; see Figure 31
Break-Before-Make Time Delay, t <sub>D</sub>	30			ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$
			21	ns min	$V_{s1} = V_{s2} = 2.5 V$ ; see Figure 30
Charge Injection	70			pC typ	$V_s = 2.5 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 32
Off Isolation	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 25
Channel-to-Channel Crosstalk	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 27
Total Harmonic Distortion + Noise	0.09			% typ	$R_L$ = 110 $\Omega,$ f = 20 Hz to 20 kHz, $V_S$ = 3.5 V p-p; see Figure 28
–3 dB Bandwidth	16			MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 26
C <sub>s</sub> (Off)	70			pF typ	$V_s = 2.5 V, f = 1 MHz$
C <sub>D</sub> (Off)	300			pF typ	$V_s = 2.5 V, f = 1 MHz$
C <sub>D</sub> , C <sub>s</sub> (On)	400			pF typ	$V_s = 2.5 V, f = 1 MHz$
POWER REQUIREMENTS					V <sub>DD</sub> = 5.5 V
lod	0.001			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
			1	µA max	
V <sub>DD</sub>			3.3/16	V min/max	

### 3.3 V SINGLE SUPPLY

 $V_{\text{DD}}$  = 3.3 V,  $V_{\text{SS}}$  = 0 V, GND = 0 V, unless otherwise noted.

### Table 4.

_		–40°C to	–40°C to		
Parameter	25°C	+85°C	+125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V <sub>DD</sub>	V	
On Resistance (R <sub>ON</sub> )	3.2			Ωtyp	$V_S = 0 V$ to $V_{DD}$ , $I_S = -10 \text{ mA}$ ; see Figure 22
	3.6	3.8	4	Ωmax	$V_{DD} = 3.3 V, V_{SS} = 0 V$
On Resistance Match Between Channels ( $\Delta R_{ON}$ )	0.06			Ω typ	$V_{s} = 0 V \text{ to } V_{DD}, I_{s} = -10 \text{ mA}$
	0.15	0.16	0.17	Ωmax	
On Resistance Flatness (R <sub>FLAT(ON)</sub> )	1.2			Ωtyp	$V_{s} = 0 V \text{ to } V_{DD}, I_{s} = -10 \text{ mA}$
	1.6	1.7	1.8	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = 3.6 V, V_{SS} = 0 V$
Source Off Leakage, Is (Off)	±0.02			nA typ	$V_s = 0.6 V/3 V$ , $V_D = 3 V/0.6 V$ ; see Figure 23
	±0.25	±1	±8	nA max	
Drain Off Leakage, I <sub>D</sub> (Off)	±0.02			nA typ	$V_{\rm S} = 0.6 \text{V}/3 \text{V}, V_{\rm D} = 3 \text{V}/0.6 \text{V}; \text{see Figure 23}$
	±0.25	±2	±16	nA max	
Channel On Leakage, I <sub>D</sub> , I <sub>S</sub> (On)	±0.05			nA typ	$V_s = V_D = 0.6 V$ or 3 V; see Figure 24
	±0.6	±2	±16	nA max	
DIGITAL INPUTS					
Input High Voltage, V <sub>INH</sub>			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current, IINL or IINH	0.001			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	µA max	
Digital Input Capacitance, C <sub>IN</sub>	8			pF typ	
DYNAMIC CHARACTERISTICS <sup>1</sup>					
Transition Time, transition	280			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	460	526	575	ns max	$V_s = 1.5 V$ ; see Figure 29
t <sub>on</sub> (EN)	227			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	308	332	346	ns max	$V_s = 1.5 V$ ; see Figure 31
t <sub>off</sub> (EN)	357			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
	480	549	601	ns max	$V_s = 1.5 V$ ; see Figure 31
Break-Before-Make Time Delay, t <sub>D</sub>	25			ns typ	$R_L = 300 \Omega, C_L = 35 pF$
			20	ns min	$V_{s1} = V_{s2} = 1.5 V$ ; see Figure 30
Charge Injection	60			pC typ	$V_s = 1.5 V$ , $R_s = 0 \Omega$ , $C_L = 1 nF$ ; see Figure 32
Off Isolation	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ;
					see Figure 25
Channel-to-Channel Crosstalk	70			dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 100 kHz$ ; see Figure 27
Total Harmonic Distortion + Noise	0.15			% typ	$R_L = 110 \Omega$ , $f = 20 Hz$ to 20 kHz, $V_S = 2 V p$ -p; see Figure 28
–3 dB Bandwidth	15			MHz typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ ; see Figure 26
C <sub>s</sub> (Off)	76			pF typ	$V_s = 1.5 V, f = 1 MHz$
$C_{D}$ (Off)	316			pF typ	$V_s = 1.5 V, f = 1 MHz$
C <sub>D</sub> , C <sub>s</sub> (On)	420			pF typ	$V_s = 1.5 V, f = 1 MHz$
POWER REQUIREMENTS				17: 717	$V_{DD} = 3.6 V$
	0.001			μA typ	Digital inputs = $0 \text{ V}$ or $V_{DD}$
	0.001	1.0	1.0	μA max	
V <sub>DD</sub>		1.0	3.3/16	V min/max	
עט <b>י</b>			5.5/10	v mm/max	

### CONTINUOUS CURRENT PER CHANNEL, S OR D

Table 5.

Parameter	25°C	85°C	125°C	Unit
CONTINUOUS CURRENT, S OR D				
$V_{DD} = +5 V, V_{SS} = -5 V$				
TSSOP ( $\theta_{JA} = 150.4^{\circ}C/W$ )	315	189	95	mA maximum
LFCSP ( $\theta_{JA} = 48.7^{\circ}C/W$ )	504	259	112	mA maximum
$V_{DD} = 12 V, V_{SS} = 0 V$				
TSSOP ( $\theta_{JA} = 150.4^{\circ}C/W$ )	378	221	112	mA maximum
LFCSP ( $\theta_{JA} = 48.7^{\circ}C/W$ )	627	311	126	mA maximum
$V_{DD} = 5 V, V_{SS} = 0 V$				
TSSOP ( $\theta_{JA} = 150.4^{\circ}C/W$ )	249	158	91	mA maximum
LFCSP ( $\theta_{JA} = 48.7^{\circ}C/W$ )	403	224	105	mA maximum
$V_{DD} = 3.3 V, V_{SS} = 0 V$				
TSSOP ( $\theta_{JA} = 150.4^{\circ}C/W$ )	256	165	98	mA maximum
LFCSP ( $\theta_{JA} = 48.7^{\circ}C/W$ )	410	235	116	mA maximum

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}C$ , unless otherwise noted.

#### Table 6.

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Parameter	Rating
V <sub>DD</sub> to V <sub>SS</sub>	18 V
V <sub>DD</sub> to GND	–0.3 V to +18 V
Vss to GND	+0.3 V to -18 V
Analog Inputs <sup>1</sup>	V <sub>SS</sub> – 0.3 V to V <sub>DD</sub> + 0.3 V or 30 mA, whichever occurs first
Digital Inputs <sup>1</sup>	GND – 0.3 V to V <sub>DD</sub> + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D	1150 mA (pulsed at 1 ms, 10% duty cycle maximum)
Continuous Current, S or D <sup>2</sup>	Data + 15%
Operating Temperature Range	
Industrial (Y Version)	–40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
16-Lead TSSOP, θ <sub>JA</sub> Thermal Impedance (2-Layer Board)	150.4°C/W
16-Lead LFCSP, θ <sub>JA</sub> Thermal Impedance (4-Layer Board)	48.7°C/W
Reflow Soldering Peak Temperature, Pb free	260°C

<sup>1</sup> Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

<sup>2</sup> See Table 5.

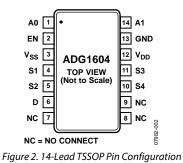
Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

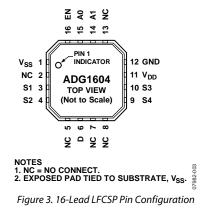
#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

### **PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS**





#### Table 7. Pin Function Descriptions

Pin No.			
TSSOP	LFCSP	Mnemonic	Description
1	15	A0	Logic Control Input.
2	16	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are off. When this pin is high, the Ax logic inputs determine the on switch.
3	1	Vss	Most Negative Power Supply Potential.
4	3	S1	Source Terminal. This pin can be an input or output.
5	4	S2	Source Terminal. This pin can be an input or output.
6	6	D	Drain Terminal. This pin can be an input or output.
7, 8, 9	2, 5, 7, 8, 13	NC	No Connection.
10	9	S4	Source Terminal. This pin can be an input or output.
11	10	S3	Source Terminal. This pin can be an input or output.
12	11	V <sub>DD</sub>	Most Positive Power Supply Potential.
13	12	GND	Ground (0 V) Reference.
14	14	A1	Logic Control Input.
N/A	17 (EPAD)	EP (EPAD)	Exposed Pad. Tied to substrate, Vss.

#### Table 8. ADG1604 Truth Table

EN	A1	A0	S1	S2	S3	S4
0	Х	Х	Off	Off	Off	Off
1	0	0	On	Off	Off	Off
1	0	1	Off	On	Off	Off
1	1	0	Off	Off	On	Off
1	1	1	Off	Off	Off	On

### **TYPICAL PERFORMANCE CHARACTERISTICS**

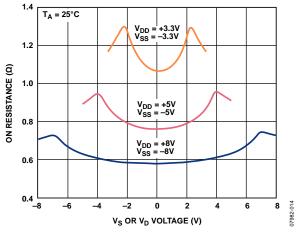


Figure 4. On Resistance as a Function of  $V_D$  (V<sub>s</sub>) for Dual Supply

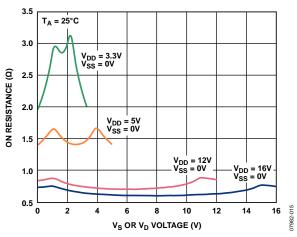


Figure 5. On Resistance as a Function of  $V_D$  (V<sub>s</sub>) for Single Supply

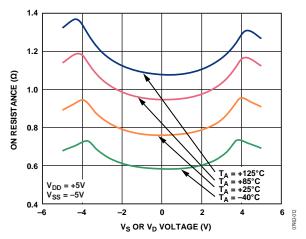


Figure 6. On Resistance as a Function of  $V_D$  (V<sub>s</sub>) for Different Temperatures,  $\pm 5$  V Dual Supply

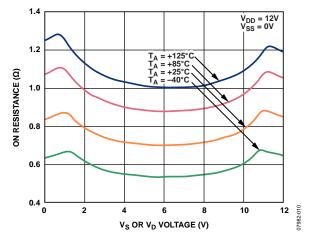


Figure 7. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures, 12 V Single Supply

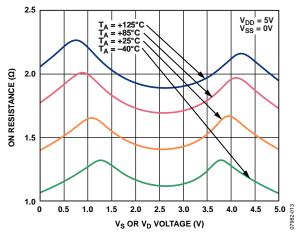


Figure 8. On Resistance as a Function of  $V_D$  (V<sub>s</sub>) for Different Temperatures, 5 V Single Supply

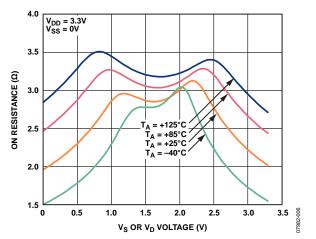


Figure 9. On Resistance as a Function of  $V_D$  (V<sub>s</sub>) for Different Temperatures, 3.3 V Single Supply

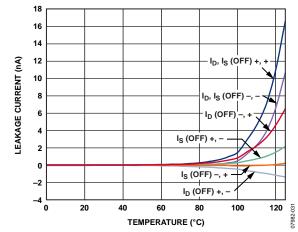
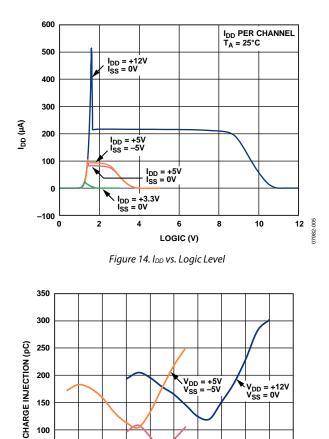


Figure 13. Leakage Currents as a Function of Temperature, 3.3 V Single Supply



V<sub>DD</sub> = +3.3V V<sub>SS</sub> = 0V

4

V<sub>S</sub> (V)

Figure 15. Charge Injection vs. Source Voltage

+5V

8

10 12 07982-009

14

0

6

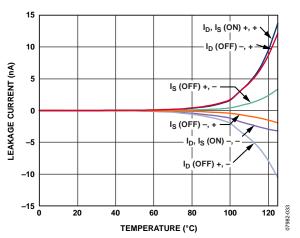


Figure 10. Leakage Currents as a Function of Temperature,  $\pm 5$  V Dual Supply

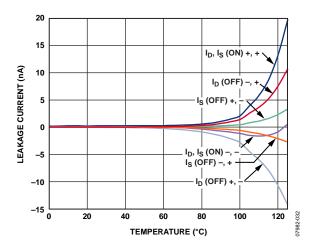


Figure 11. Leakage Currents as a Function of Temperature, 12 V Single Supply

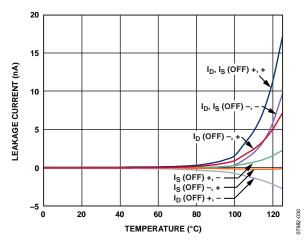


Figure 12. Leakage Currents as a Function of Temperature, 5 V Single Supply

150

100

50

0

-6 -4 -2 0 2

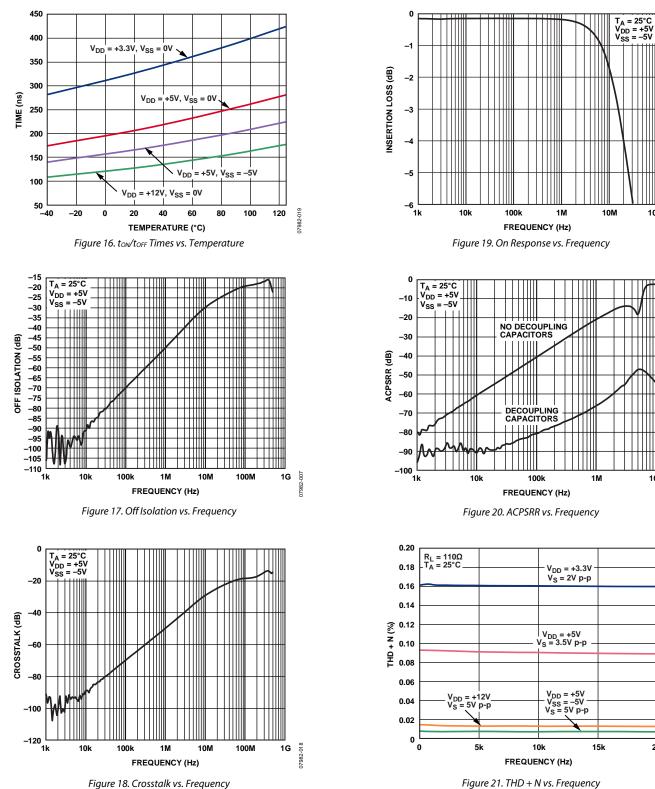


Figure 21. THD + N vs. Frequency

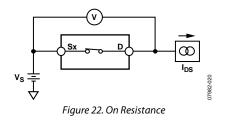
100M ∛

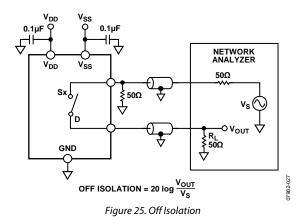
10M 07982-008

20k 20k

7982.

# **TEST CIRCUITS**





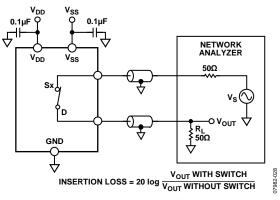
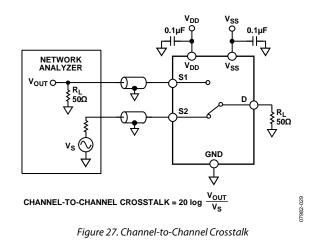
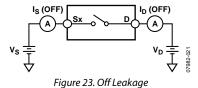
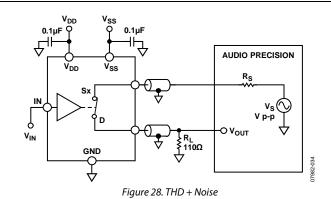
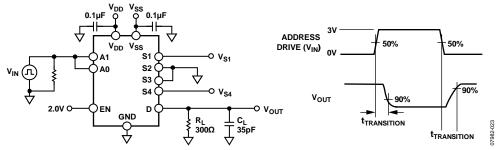


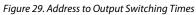
Figure 26. Bandwidth

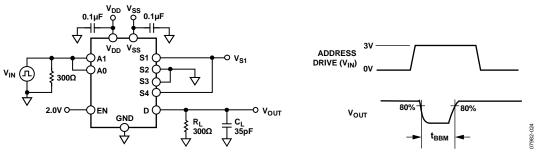


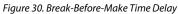


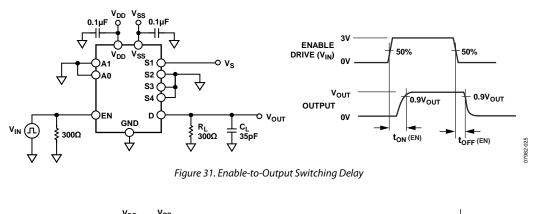












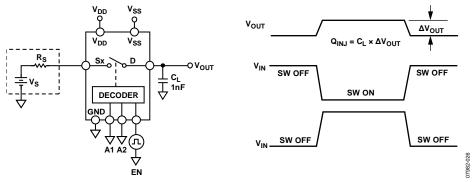


Figure 32. Charge Injection

### TERMINOLOGY

#### IDD

The positive supply current.

### Iss

The negative supply current.

### $\mathbf{V}_{\mathrm{D}}$ (Vs)

The analog voltage on Terminal D and Terminal S.

### Ron

The ohmic resistance between Terminal D and Terminal S.

### R<sub>FLAT(ON)</sub>

Flatness that is defined as the difference between the maximum and minimum value of on resistance measured over the specified analog signal range.

### Is (Off)

The source leakage current with the switch off.

 $\mathbf{I}_{\mathrm{D}}$  (Off) The drain leakage current with the switch off.

 $I_D$ ,  $I_S$  (On) The channel leakage current with the switch on.

VINL

The maximum input voltage for Logic 0.

 $V_{\mbox{\scriptsize INH}}$  The minimum input voltage for Logic 1.

 $I_{\rm INL} \left( I_{\rm INH} \right)$  The input current of the digital input.

### Cs (Off)

The off switch source capacitance, which is measured with reference to ground.

### C<sub>D</sub> (Off)

The off switch drain capacitance, which is measured with reference to ground.

### $C_D, C_S(On)$

The on switch capacitance, which is measured with reference to ground.

### CIN

The digital input capacitance.

#### **t**TRANSITION

The delay time between the 50% and 90% points of the digital input and switch on condition when switching from one address state to another.

### ton (EN)

The delay between applying the digital control input and the output switching on. See Figure 31.

### toff (EN)

The delay between applying the digital control input and the output switching off. See Figure 31.

### **Charge Injection**

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

### **Off Isolation**

A measure of unwanted signal coupling through an off switch.

#### Crosstalk

A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.

### Bandwidth

The frequency at which the output is attenuated by 3 dB.

### On Response

The frequency response of the on switch.

### Insertion Loss

The loss due to the on resistance of the switch.

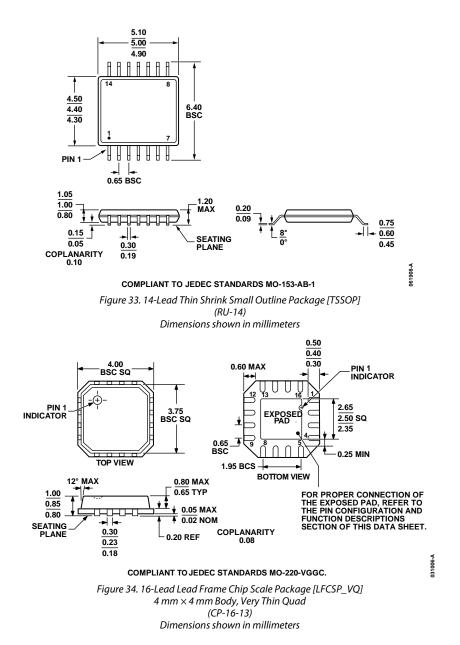
### Total Harmonic Distorition + Noise (THD + N)

The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

### AC Power Supply Rejection Ratio (ACPSRR)

The ratio of the amplitude of signal on the output to the amplitude of the modulation. This is a measure of the ability of the part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p.

### **OUTLINE DIMENSIONS**



#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option
ADG1604BRUZ <sup>1</sup>	-40°C to +125°C	14-Lead Thin Shrink Small Outline Package [TSSOP]	RU-14
ADG1604BRUZ-REEL <sup>1</sup>	-40°C to +125°C	14-Lead Thin Shrink Small Outline Package [TSSOP]	RU-14
ADG1604BRUZ-REEL71	–40°C to +125°C	14-Lead Thin Shrink Small Outline Package [TSSOP]	RU-14
ADG1604BCPZ- REEL <sup>1</sup>	-40°C to +125°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-13
ADG1604BCPZ-REEL71	-40°C to +125°C	16-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-16-13

<sup>1</sup> Z = RoHS Compliant Part.

# NOTES

# NOTES

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